

**2019 EXHIBITOR FORUM SCHEDULE**

<b>MONDAY 4/29/19</b>	<b>EXHIBITOR</b>	<b>SPEAKER</b>	<b>TITLE</b>	<b>PRESENTATION TOPIC</b>
6:15PM to 6:25PM	Wolfspeed	Chris Dimino	Director, Global Sales and Marketing SiC Materials	Wolfspeed Materials: Leading the Industry Conversion to Silicon Carbide
6:30PM to 6:40PM	ePak	Nik Tryer	Sales	What's New at ePak!!
6:45PM to 6:55PM	ASAP/AXR	Greg Mills	Director of Sales	High Throughput Single Wafer Lift Off - Spin Technology
7:00PM to 7:10PM	II-VI Advanced Materials	Andy Souzis	Director of Business Development	What's New at II-VI!!
7:15PM to 7:25PM	Bruker Semiconductor	Oli Whear	Product Marketing Manager	Bruker Semi X-Ray Products
7:30PM to 7:40PM	ANNEALSYS	Henri De LosRios	Global Business Development Manager	ANNEALSYS RTP / DLI Products
7:45PM to 7:55PM	Beneq	Patrick Rabinzohn	Business Executive, Semiconductor ALD, Beneq	Industrial Applications of ALD for Compound Semiconductor
8:00PM to 8:10PM	LayTec	Dr. Kamau Prince	Technical Sales	Metrology for MOCVD Processes
8:15PM to 8:25PM	Canon USA	Doug Shelton	Marketing Manager	Canon Technologies Enabling Compound Semiconductor Innovation
8:30PM to 8:40PM	Oxford Instruments	Robert Gunn	Strategic Marketing Manager	Oxford Instruments Plasma Technology
8:45PM to 8:55PM	Nanotronics	Shivani Iyer	Solutions Architect	Inspection Convergence: Photoluminescence Imaging and AI
<b>TUESDAY 4/30/19</b>	<b>EXHIBITOR</b>	<b>SPEAKER</b>	<b>TITLE</b>	<b>PRESENTATION TOPIC</b>
1:00PM to 1:10PM	Revasum	Sarah Okada	VP Products & Mktg	SiC Substrate Processing
1:15PM to 1:25PM	GT Advanced Technologies	Henry Chou	Global SiC Product Manager	Silicon Carbide: Overcoming Cost and Availability Challenges
1:30PM to 1:40PM	EpiGaN	Dr. Markus Behet	Chief Marketing Officer	GaN/Si - A key enabling technology for 5g
1:45PM to 1:55PM	PlasmaTherm	Yannick Pilloux	General Manager Ion Beam Products Group	Patterning AlN and ScAlN Thin Films by IBE / RIBE for BAW applications
2:00PM to 2:10PM	Evatec	Carlo Tosi	Product Marketing Manager	Innovation in Production Solutions for High Performance Thin Film Piezoelectrics
2:15PM to 2:25PM	SPTS Technologies	Richard Barrett	Etch Product Manager	Process Solutions for Compound Semiconductors
2:30PM to 2:40PM	AIXTRON	Christof Sommerhalter	General Manager	AIXTRON MOCVD Production Technology for GaAs/InP, GaN, and SiC Materials
2:45PM to 2:55PM	DISCO Hi-Tec	Chris Mihai	Technology & Business Development	Advanced Singulation of III-V Materials
3:00PM to 3:10PM	Yield Engineering Systems	Bill Moffat	Founder & CTO	"Providing Solutions through 3 C's (Cure, Clean and Coat)"
3:15PM to 3:25PM	Inspectrology LLC	Paul Knutrud	VP of Marketing & Finance	Challenges of Metrology for Exotic III-V Materials
3:30PM to 3:40PM	Nel Hydrogen	John Speranza	VP Product Sales & Mktg	Benefits of On-Site Hydrogen
3:45PM to 3:55PM	Toho	Didi von Ddiemar	Account Manager	Metrology Tools for Compound Semiconductor
4:00PM to 4:10PM	PicoSun	Dr. Wilfredo Cabrera	General Manager	Unique ALD Applications
4:15PM to 4:25PM	MSE Supplies, LLC	Sam Zhu, Ph.D	Scientist and Business Executive	Supplying High Quality SiC Wafers and GaN Substrates to the Compound Semi Industry
4:30PM to 4:40PM	Engis Corporation	Alicia Walters	Product Manager, Hyprez	CMP Options for Silicon Carbide Wafers
4:45PM to 4:55PM	Cyber Technologies	Karl-Heinz Strass	Managing Director	Advancements in Optical Metrology
5:00PM to 5:10PM	Pozzetta	Artemis Vasiliades	Account Executive	Secure Environments for Semiconductor Materials